

SmartFusion2 Development Kit Quickstart Guide

Kit Contents – SF2-DEV-KIT

Quantity	Description
1	SmartFusion [®] 2 Development Board with M2S050T-1FGG896
1	FlashPro4 programmer
1	USB A to Micro B cable
1	USB Micro A to A cable
1	USB A to Mini-B cable
1	PCI edge card ribbon cable
1	12 V power adapter

Overview

Microsemi's SmartFusion2 Development Kit offers a full-featured development board for SmartFusion2 System-on-Chip (SoC) FPGAs, which integrate inherently reliable flash-based FPGA fabric, a 166 MHz ARM[®] Cortex[™]-M3 processor, advanced security processing accelerators, DSP blocks, SRAM, eNVM and industry-required high-performance communication interfaces, all on a single chip.

The board contains numerous transceivers to support the built-in microcontroller subsystem, such as high speed USB 2.0 On-the-Go (OTG), CAN RS232, RS484, and IEEE1588 time-stamping and Sync E capable Triple Speed Ethernet PHYs. The kit ships with a wall mounted power supply but also has the option to be powered through Power over Ethernet (PoE), includes a 16-bit analog-to-digital converter (ADC) and has IEEE 1588 packet time-stamping capabilities. There is also 512 MB of on-board DDR3 memory and SPI flash to utilize the SmartFusion2 memory management system. The SERDES blocks can be accessed via the PCI edge connector or high speed SMP connectors.

SmartFusion2 Development Kit Board

Devices On-Board	Interfaces/Connectors
- M2S050T-1FGG896 50K look-up table (LUT), 256 Kbit eNVM, 1.5 Mbit SRAM, and additional distributed SRAM in the FPGA fabric and external memory controller - Peripherals include Triple Speed Ethernet, USB 2.0, SPI, CAN, DMAs, I2Cs, UARTs, timers 6x 5 Gbps SERDES, PCIe, XAUI/XGXS+ Native SERDES - Refer to the SmartFusion2 product page for full device information - ZL30362 – IEEE 1588 and Synchronous Ethernet Packet Clock Network Synchronizer - Power over Ethernet (PoE) - Up to 48 W of power - Power supply module required: PD-9501G/AC (not supplied) - Precision analog-to-digital converter (ADC) 16-bit, 500 Ksps, 8-channel, single-ended for mixed signal power management - DDR/SDRAM 512 MB of DDR3 memory on-board 256 MB for ECC 16MB of SDRAM - eMMC 4GB NAND flash memory - SPI flash 8 MB module	- JTAG interface for Microsemi's FlashPro4 programming and Cortex-M3 processor - Embedded Trace Macro connector - USB 2.0 On-The-Go (OTG) Controller - RS232 port for USB-to-UART connection - Two DB9 connectors for CAN ports - RJ45 connector for PoE (Power over Ethernet) power. - Two RJ45 connectors for TSE Ethernet operation or SGMII mode - SERDES Interfaces Include - X4 PCIe Gen1/Gen2 edge fingers 4 Tx/Rx high speed SMP connectors - FMC header supporting 4 SERDES channels - High speed memory interface supporting LPDDR, DDR2, DDR3, and SDRAM memories - FMC header for daughtercard support - GPIO header for debugging purposes - I2C headers - SPI headers

Block Diagram

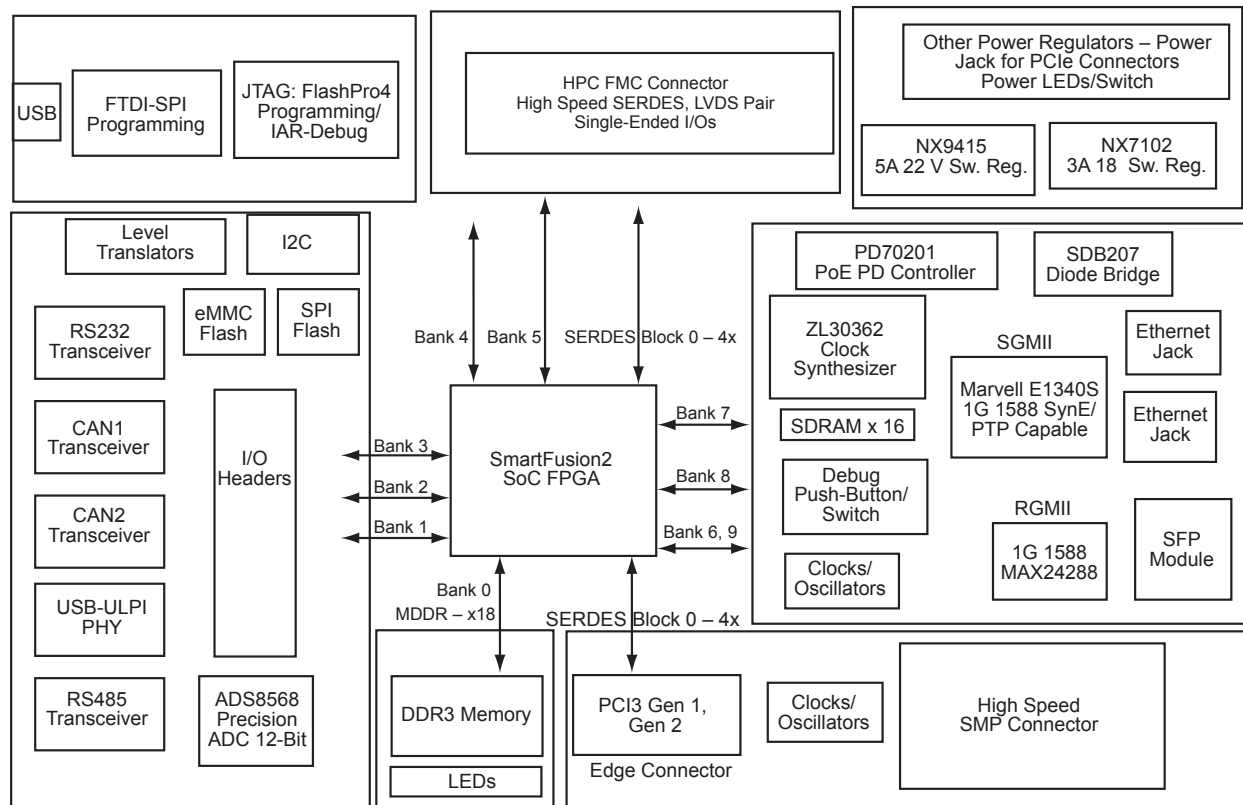


Figure 1 • SmartFusion2 Interfaces/Connectors Block Diagram

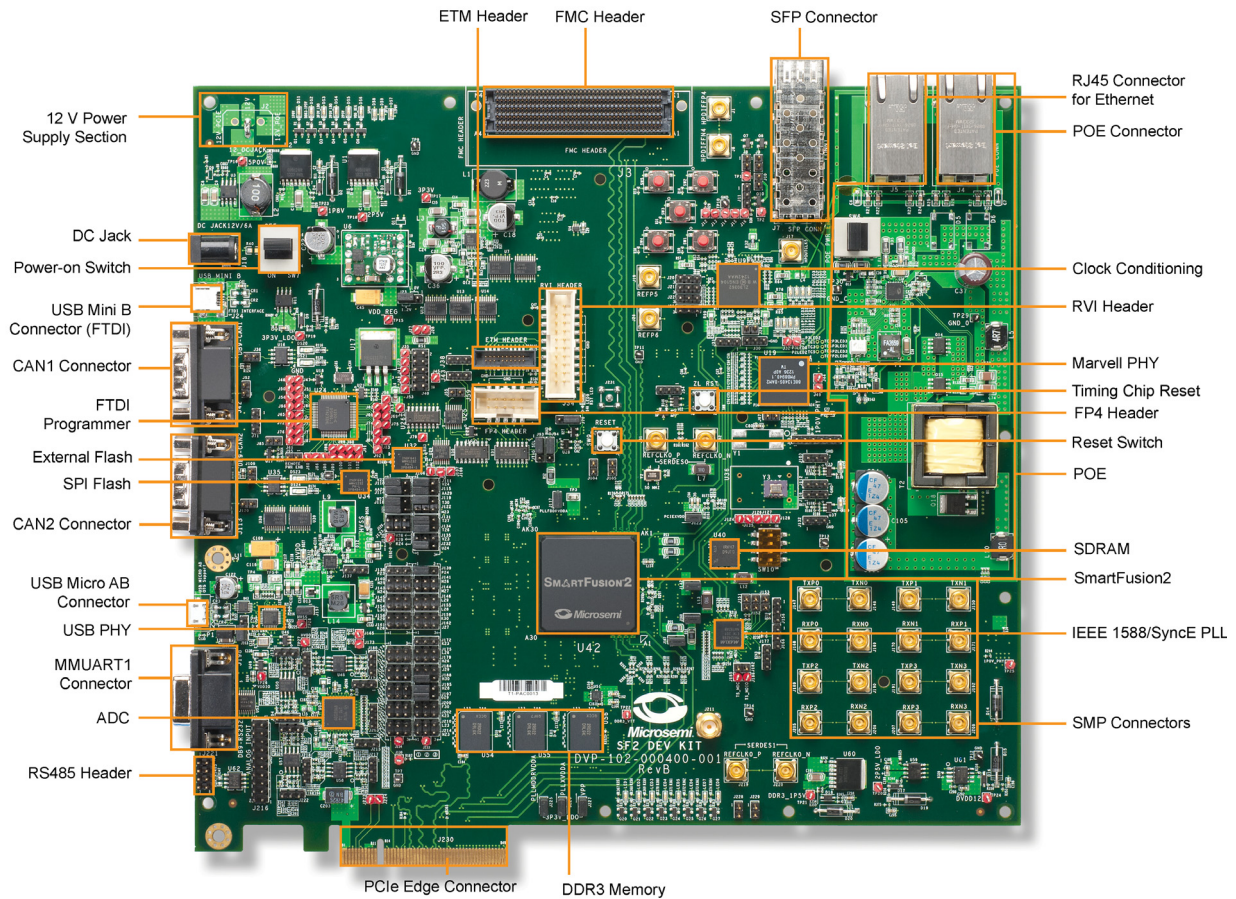
Jumper Settings

Jumper	Setting	Function	Jumper	Setting	Function
J195	1-2		J163	1-2	USB Test
J188	1-2		J164	1-2	USB Test
J197	1-2		J114	1-2	CAN1 Test
J121	1-2	SPI Test	J115	1-2	CAN1 Test
J110	1-2	SPI Test	J111	1-2	CAN1 Test
J119	1-2	SPI Test	J134	1-2	CAN2 Test
J118	1-2	SPI Test	J131	1-2	CAN2 Test
J139	1-2	USB Test	J232	1-2	CAN2 Test

Connecting the Board

Follow the steps below to connect the board:

1. Connect the USB mini-B cable from your PC to the USB Mini-B connector (FTDI) interface on the board.
2. Connect the FlashPro4 programmer to your PC via the USB mini-B cable.
3. Connect the FlashPro4 programmer to the board via the FP4 header.
4. Connect the 12 V DC power supply to a wall outlet and to the board via the DC jack.
5. Switch the power on to the board via the power-on switch (SW7)



List of Changes

The following table lists the critical changes that were made in each revision of the document.

Revision*	Changes	Page
Revision 1 (January 2014)	Updated the document to remove PP in the device name (SAR 54072).	NA
	Updated device part number in "Kit Contents – SF2-DEV-KIT" section and "SmartFusion2 Development Kit Board" section (SAR 54072).	NA
	Corrected power-on switch in "Connecting the Board" section (SAR 54072).	3
Revision 0 (March 2013)	Initial Release	NA

Note: *The revision number is located in the part number after the hyphen. The part number is displayed at the bottom of the last page of the document. The digits following the slash indicate the month and year of publication.

Software and Licensing

The SmartFusion2 Development Kit is supported by Libero® System-on-Chip (SoC) software v11.0 Beta SP1. SoftConsole software IDE and FlashPro software tools can be used for software design and debug. SmartFusion2 is also supported by Keil and IAR Systems software, which can be installed separately. Refer to the [SmartFusion2 Development Kit User Guide](#) for more information.

Software releases:

www.microsemi.com/index.php?option=com_content&id=1574&lang=en&view=article#downloads

Keil and IAR information:

www.microsemi.com/index.php?option=com_content&Itemid=2823&id=1563&lang=en&view=article

Libero SoC v11.0 and later requires a valid Gold, Platinum, or standalone Libero license. If you need a new license, select FREE Libero SoC Gold license and request a new one from your Microsemi Customer Portal account. This license supports all tools for designing with the SmartFusion2 family and associated development kits.

License updates: <https://soc.microsemi.com/Portal/default.aspx?r=1>

Documentation Resources

For further kit information, including user's guide, tutorial, and full design examples, refer to the SmartFusion2 Development Kit page:

Documentation: www.microsemi.com/index.php?option=com_content&id=1645&lang=en&view=article#documents

As new demos and tutorials become available, they will be posted on the SmartFusion2 Development Kit web page. Microsemi recommends that you sign up for Product Updates to be notified when new material is available. You can sign up for product updates from your Microsemi Customer Portal account.

Product updates: <https://soc.microsemi.com/Portal/default.aspx?r=2>

Technical Support and Contacts

Technical support is available online at

www.microsemi.com/index.php?option=com_content&id=2112&lang=en&view=article and by email at soc_tech@microsemi.com.

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